292251-9 <

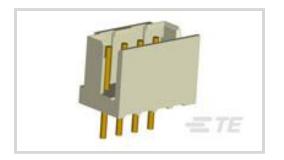
AMP CT

TE Internal #: 292251-9 PCB Mount Header, Vertical, Wire-to-Board, 9 Position, .079 in [2 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMP CT

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > CT 2mm Post Header Asmbly: Box V DIP



Connector System: Wire-to-Board

Number of Positions: 9

Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in]

PCB Mount Orientation: Vertical

All CT 2mm Post Header Asmbly: Box V DIP (81)

Features

Product Type Features

Connector System

Header Type

Wire-to-Board

Partially Shrouded

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	9
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	125 VAC
Body Features	
Primary Product Color	Natural
Contact Features	
Contact Layout	Inline
Contact Mating Area Length	4.2 mm[.165 in]

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, .079 in [2 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMP CT



PCB Contact Termination Area Plating Material Thickness	1 μm[39.37 μin]
Mating Pin Diameter	.6 mm[.024 in]
Contact Mating Area Plating Material Thickness	1 μm[39.37 μin]
Contact Shape & Form	Round
Contact Mating Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	4 A
Termination Features	
Round Termination Post & Tail Diameter	.6 mm[.024 in]
Termination Post & Tail Length	3.2 mm[.126 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
Mating Alignment Type	Polarization
Mating Retention	Without
PCB Mount Retention Type	Boardlock
Mating Retention Type	Detent Window
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	With
PCB Mount Retention	With
Housing Features	
Housing Material	Nylon 66
Centerline (Pitch)	2 mm[.079 in]
Dimensions	
Connector Length	19.8 mm[.78 in]
Connector Height	6.8 mm[.267 in]
Connector Width	5.8 mm[.228 in]
PCB Thickness (Recommended)	.8 mm[.031 – .063 in]

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, .079 in [2 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMP CT



Usage Conditions

Operating Temperature Range	-40 – 105 °C[-40 – 105 °F]
Operation/Application	
Assembly Process Feature	Pick and Place Cover
Circuit Application	Power & Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	500
Packaging Type	Bag, Box
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224)

Halogen Content

Solder Process Capability

(224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, .079 in [2 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMP CT



Compatible Parts



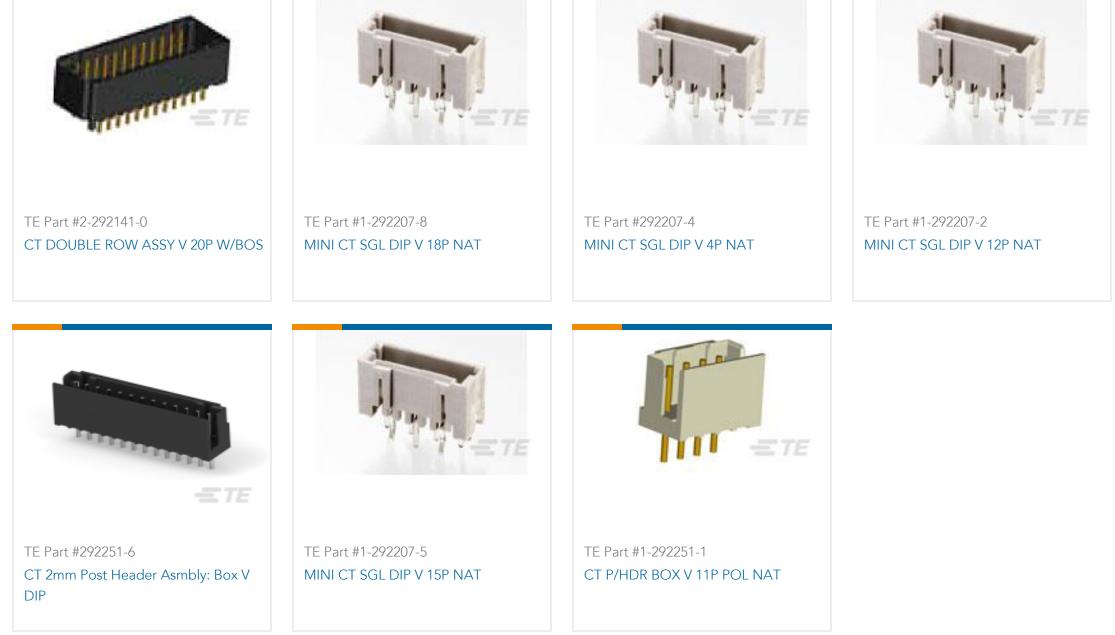


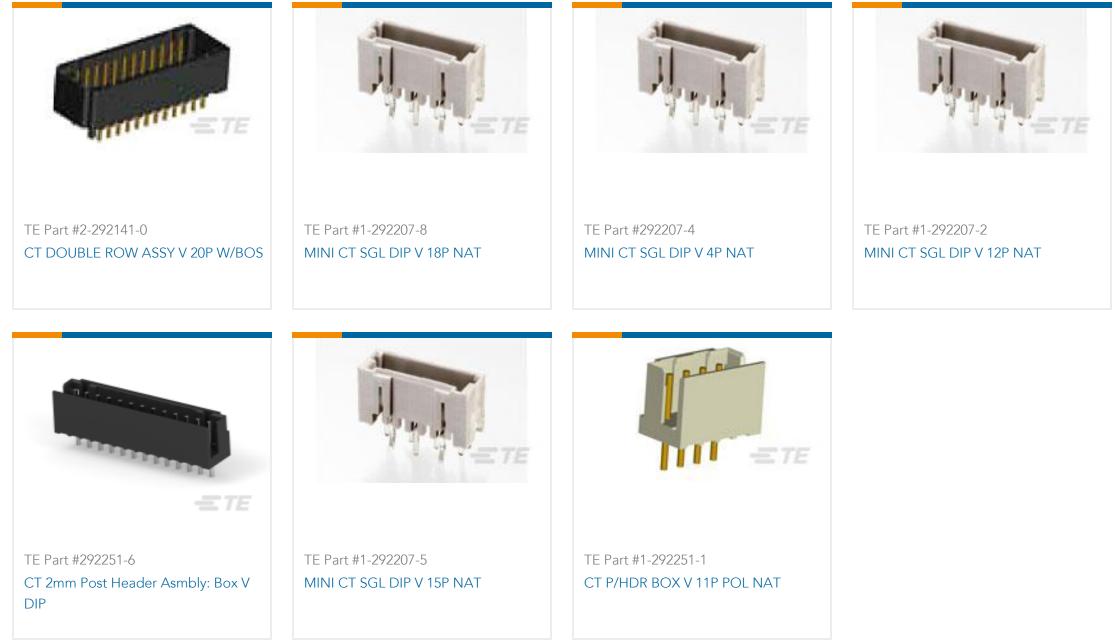
TE Part # 173977-9 CT CONN MT REC ASSY 9P

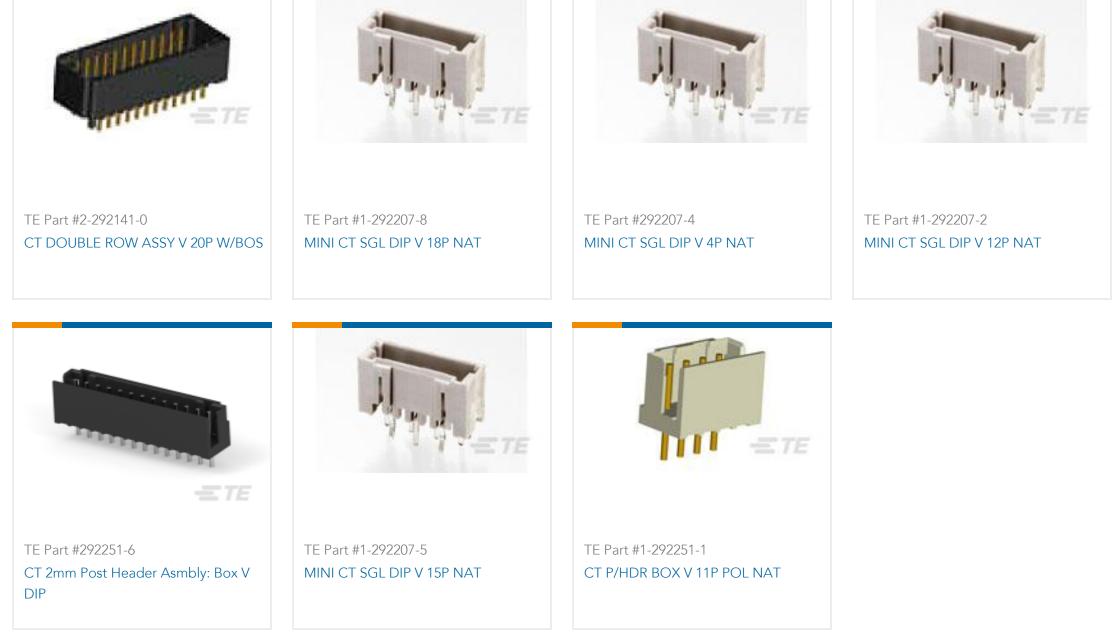
Also in the Series AMP CT

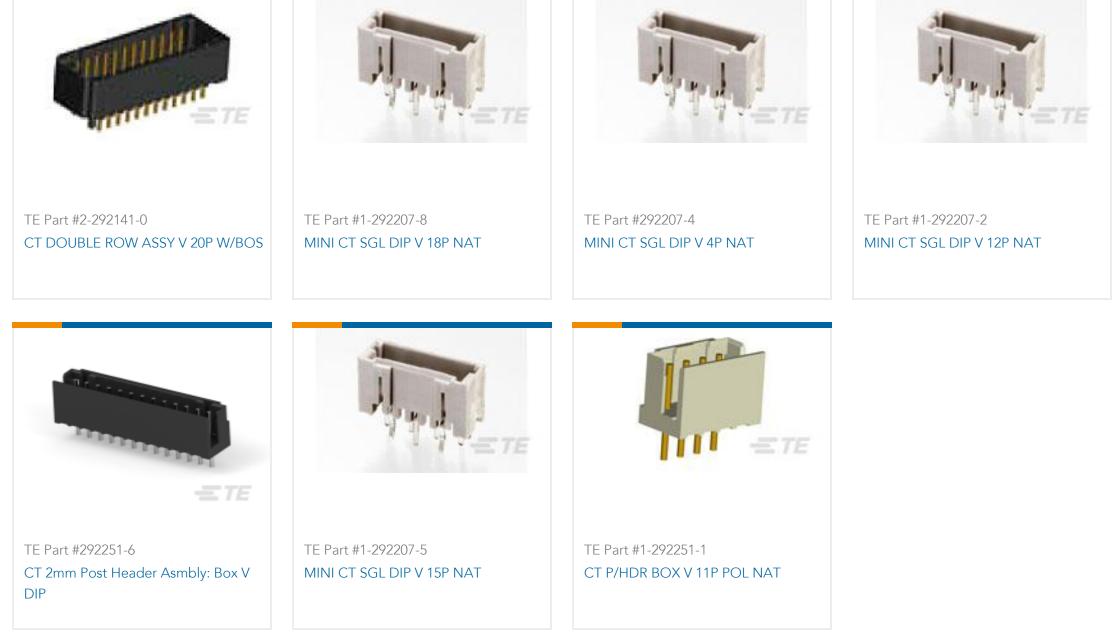


Customers Also Bought









Documents

Product Drawings CT P/HDR BOX V 9P POL NAT

English

CAD Files

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, .079 in [2 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMP CT



3D PDF

English

Customer View Model

ENG_CVM_292251-9_B.3d_igs.zip

English

Customer View Model

ENG_CVM_292251-9_B.3d_stp.zip

English

Customer View Model

ENG_CVM_292251-9_B.2d_dxf.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Product Specifications AMP COMMON TERMINATION (CT), CONNECTOR, 2mm PITCH, M/T TYPE, LEAD FREE VERSION

Japanese

Product Specification

Japanese

Product Environmental Compliance

MD_292251-9_12272017717_dmtec

English

MD_292251-9_12272017717_dmtec

English